## 1. General description

The 74ALVCH16652 consists of 16 non-inverting bus transceiver circuits with 3-state outputs, D-type flip-flops and control circuitry arranged for multiplexed transmission of data directly from the data bus or from the internal storage registers.

Data on the 'A' or 'B', or both buses, will be stored in the internal registers, at the appropriate clock inputs (nCPAB or nCPBA) regardless of the select inputs (nSAB and nSBA) or output enable (nOEAB and nOEBA) control inputs.

Depending on the select inputs nSAB and nSBA data can directly go from input to output (real-time mode) or data can be controlled by the clock (storage mode), when OE inputs permit this operating mode.

The output enable inputs nOEAB and nOEBA determine the operation mode of the transceiver. When nOEAB is LOW, no data transmission from nBn to nAn is possible and when nOEBA is HIGH, no data transmission from nBn to nAn is possible.

When nSAB and nSBA are in the real-time transfer mode, it is also possible to store data without using the internal D-type flip-flops by simultaneously enabling nOEAB and nOEBA. In this configuration each output reinforces its input.

Active bus hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

### 2. Features and benefits

- Wide supply voltage range of 1.2 V to 3.6 V
- CMOS low power consumption
- · Direct interface with TTL levels
- Current drive ±24 mA at V<sub>CC</sub> = 3.0 V.
- MULTIBYTE<sup>™</sup> flow-through standard pin-out architecture
- Low inductance multiple V<sub>CC</sub> and GND pins for minimum noise and ground bounce
- All data inputs have bushold
- Output drive capability 50 Ω transmission lines at 85 °C
- · Complies with JEDEC standards:
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C

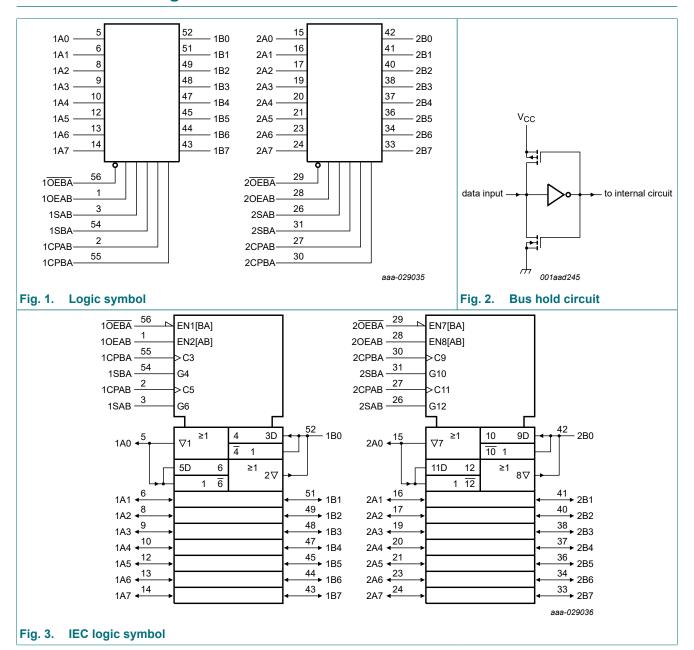
# 3. Ordering information

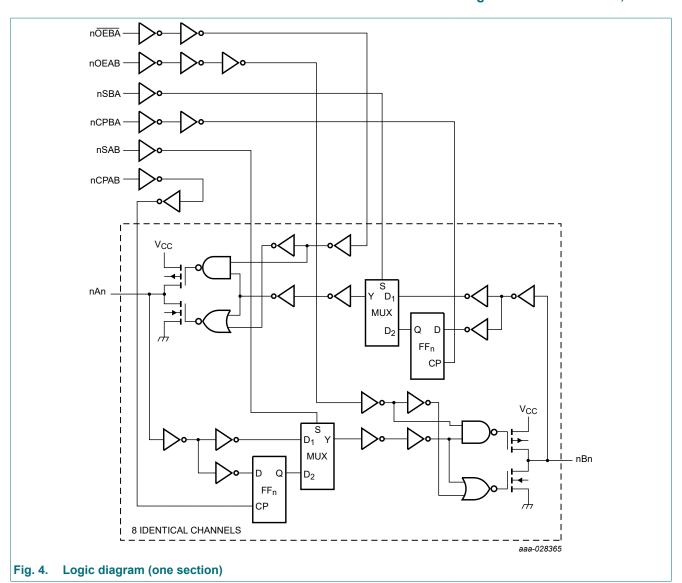
#### **Table 1. Ordering information**

Type number	Package	ackage							
	Temperature range	Name	Description	Version					
74ALVCH16652DGG	−40 °C to +85 °C	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1					



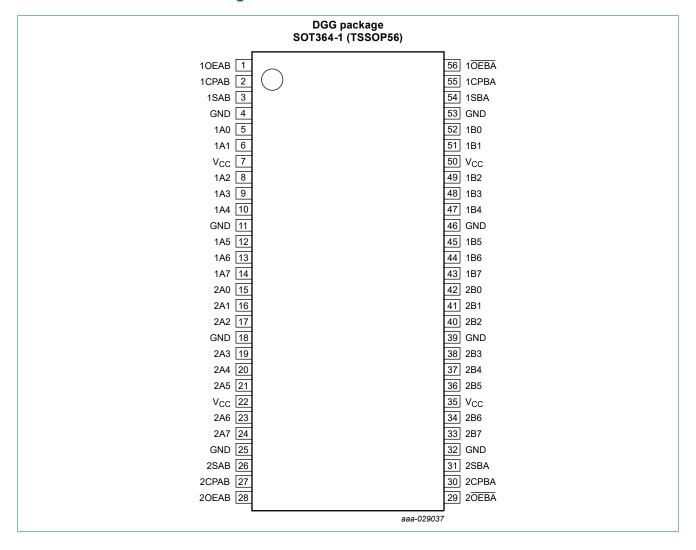
# 4. Functional diagram





## 5. Pinning information

## 5.1. Pinning



## 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1A0, 1A1, 1A2, 1A3, 1A4, 1A5, 1A6, 1A7	5, 6, 8, 9, 10, 12, 13, 14	data input/output
2A0, 2A1, 2A2, 2A3, 2A4, 2A5, 2A6, 2A7	15, 16, 17, 19, 20, 21, 23, 24	data input/output
1B0, 1B1, 1B2, 1B3, 1B4, 1B5, 1B6, 1B7	52, 51, 49, 48, 47, 45, 44, 43	data output/input
2B0, 2B1, 2B2, 2B3, 2B4, 2B5, 2B6, 2B7	42, 41, 40, 38, 37, 36, 34, 33	data output/input
1 <del>OEBA</del> , 2 <del>OEBA</del>	56, 29	output enable inputs (active-LOW)
10EAB, 20EAB	1, 28	output enable inputs (active-HIGH)
1SAB, 2SAB	3, 26	select input A-to-B
1CPAB, 2CPAB	2, 27	clock input A-to-B
1SBA, 2SBA	54, 31	select input B-to-A
1CPBA, 2CPBA	55, 30	clock input B-to-A
GND	4, 11, 18, 25, 32, 39, 46, 53	ground (0 V)
V <sub>CC</sub>	7, 22, 35, 50	supply voltage

# 6. Functional description

#### **Table 3. Function selection**

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care; \ \uparrow = LOW-to-HIGH \ clock \ transition.$ 

Operating mode	Inputs						Data I/O	
	nOEAB	nOEBA	nCPAB	nCPBA	nSAB	nSBA	nAn	nBn
isolation, store A and B data	L	Н	1	1	Х	Х	input	input
isolation, store A and B data	L	Н	H or L	H or L	Х	Х	input	input
store A, hold B[1]	Х	Н	1	H or L	Х	Х	input	unspecified[1]
store A in both registers	Н	Н	1	1	L	Х	input	output
store B, hold A[1]	L	Х	H or L	1	Х	Х	unspecified[1]	input
store B in both registers	L	L	1	1	Х	L	output	input
real-time B data to A bus	L	L	Х	Х	Х	L	output	input
stored B data to A bus	L	L	Х	H or L	Х	Н	output	input
real-time A data to B bus	Н	Н	Х	Х	L	Х	input	output
stored A data to B bus	Н	Н	H or L	X	Н	Х	input	output
stored A data to B bus and stored B data to A bus	Н	L	H or L	H or L	Н	Н	output	output

<sup>[1]</sup> The data output functions may be enabled or disabled by various signals at the nOEAB and nOEBA inputs. Data input functions are always enabled, i.e., data at the bus inputs will be stored on every LOW-to-HIGH transition on the clock inputs.

## 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
VI	input voltage	[1]	-0.5	+4.6	V
V <sub>O</sub>	output voltage	[1]	-0.5	V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
I <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
I <sub>O (sink/source)</sub>	output sink or source current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mΑ
I <sub>CC</sub>	supply current		-	100	mΑ
I <sub>GND</sub>	ground current		-100	-	mΑ
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage	for low-voltage applications	1.2	2.4	3.6	V
		for maximum speed performance; 30 pF output load	2.3	2.5	2.7	V
		for maximum speed performance; 50 pF output load	3.0	3.3	3.6	V
VI	input voltage		0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+85	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.3 V to 3.0 V	-	-	20	ns/V
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	10	ns/V

## 9. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °C to +85 °C			
			Min	Typ[1]	Max	
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	1.2	-	V
	input voltage	V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	1.5	-	V
$V_{IL}$	LOW-level	V <sub>CC</sub> = 2.3 V to 2.7 V	-	1.2	0.7	V
	input voltage	V <sub>CC</sub> = 2.7 V to 3.6 V	-	1.5	8.0	V

**Product data sheet** 

Symbol	Parameter	Conditions	-40	°C to +85 °C		Unit
			Min	Typ[1]	Max	1
V <sub>OH</sub>	HIGH-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
	output voltage	I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 2.3 V to 3.6 V	V <sub>CC</sub> - 0.2	V <sub>CC</sub>	-	V
		$I_O = -6 \text{ mA}; V_{CC} = 2.3 \text{ V}$	V <sub>CC</sub> - 0.3	V <sub>CC</sub> - 0.08	-	V
		$I_O = -12 \text{ mA}; V_{CC} = 2.3 \text{ V}$	V <sub>CC</sub> - 0.6	V <sub>CC</sub> - 0.26	-	V
		I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V	V <sub>CC</sub> - 0.5	V <sub>CC</sub> - 0.14	-	V
		$I_O = -12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	V <sub>CC</sub> - 0.6	V <sub>CC</sub> - 0.09	-	V
		I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V	V <sub>CC</sub> - 1.0	V <sub>CC</sub> - 0.28	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
0_	output voltage	I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 2.3 V to 3.6 V	-	GND	0.20	V
		$I_{O}$ = 6 mA; $V_{CC}$ = 2.3 V	-	0.07	0.40	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.15	0.70	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V	-	0.14	0.40	V
		I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V	-	0.27	0.55	V
l <sub>l</sub>	input leakage current	V <sub>CC</sub> = 2.3 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND	-	0.1	5	μΑ
l <sub>OZ</sub>	OFF-state output current	$V_{CC}$ = 2.3 V to 3.6 V; $V_I$ = $V_{IH}$ or $V_{IL}$ ; $V_O$ = $V_{CC}$ or GND	-	0.1	10	μА
I <sub>CC</sub>	supply current	V <sub>CC</sub> = 2.3 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A	-	0.2	40	μΑ
ΔI <sub>CC</sub>	additional supply current	per data I/O pin; V <sub>CC</sub> = 2.3 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A	-	150	750	μΑ
I <sub>BHL</sub>	bus hold LOW	V <sub>CC</sub> = 2.3 V; V <sub>I</sub> = 0.7 V	45	-	-	μA
	current	V <sub>CC</sub> = 3.0 V; V <sub>I</sub> = 0.8 V	75	150	-	μΑ
I <sub>BHH</sub>		V <sub>CC</sub> = 2.3 V; V <sub>I</sub> = 1.7 V	-45	-	-	μΑ
	current	V <sub>CC</sub> = 3.0 V; V <sub>I</sub> = 2.0 V	-75	-175	-	μΑ
I <sub>BHLO</sub>	bus hold LOW overdrive current	V <sub>CC</sub> = 3.6 V	500	-	-	μΑ
I <sub>внно</sub>	bus hold HIGH overdrive current	V <sub>CC</sub> = 3.6 V	-500	-	-	μΑ
C <sub>I</sub>	input capacitance		-	4.0	-	pF

<sup>[1]</sup> All typical values are measured at  $T_{amb}$  = 25 °C.

# 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit, see Fig. 10.

Symbol	Parameter	Conditions		-40 °C to +85 °C		Unit
			Min	Typ [1]	Max	
t <sub>pd</sub>		nAn to nBn; nBn to nAn; see Fig. 5 [2]				
	delay	V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	2.7	4.8	ns
		V <sub>CC</sub> = 2.7 V	-	2.8	4.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.6	3.9	ns
		nCPAB to nBn; nCPBA to nAn; see Fig. 6				
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	3.4	6.8	ns
		V <sub>CC</sub> = 2.7 V	-	3.1	5.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.4	2.9	4.5	ns
		nSAB to nBn; nSBA to nAn; see Fig. 7				
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	3.4	5.6	ns
		V <sub>CC</sub> = 2.7 V	-	3.5	6.4	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.3	3.1	5.3	ns
t <sub>en</sub>	enable	nOEAB to nBn; see Fig. 9 [3]				
	time	V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	2.6	4.5	ns
		V <sub>CC</sub> = 2.7 V	-	2.4	4.6	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.2	4.0	ns
		nOEBA to nAn; see Fig. 9 [3]				
		V <sub>CC</sub> = 2.3 V to 2.7 V	3.3	2.8	4.5	ns
		V <sub>CC</sub> = 2.7 V	-	3.0	4.6	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.2	4.0	ns
t <sub>dis</sub>	disable	nOEAB to nBn; see Fig. 9 [4]				
alo	time	V <sub>CC</sub> = 2.3 V to 2.7 V	1.6	2.7	4.5	ns
		V <sub>CC</sub> = 2.7 V	_	3.4	5.1	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.4	2.7	4.5	ns
		nOEBA to nAn; see Fig. 9 [4]				
		V <sub>CC</sub> = 2.3 V to 2.7 V	3.3	2.5	4.5	ns
		V <sub>CC</sub> = 2.7 V	_	3.1	5.1	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.1	2.9	4.5	ns
t <sub>w</sub>	pulse width	nCPAB HIGH or LOW; nCPBA HIGH or LOW; see Fig. 6				
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.2	1.2	_	ns
		V <sub>CC</sub> = 2.7 V	3.3	1.0	_	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	3.3	0.7	_	ns
t <sub>su</sub>	set-up time	nAn to nCPAB; nBn to nCPBA; see Fig. 8				
Ju		V <sub>CC</sub> = 2.3 V to 2.7 V	2.2	0.2	-	ns
		V <sub>CC</sub> = 2.7 V	1.7	0.2	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.4	0.3	_	ns

Symbol	Parameter	Conditions		-40 °C to +85 °C	;	Unit
			Min	Typ [1]	Max	
t <sub>h</sub>	hold time	nAn to nCPAB; nBn to nCPBA; see Fig. 8				
		V <sub>CC</sub> = 2.3 V to 2.7 V	0.6	0.1	-	ns
		V <sub>CC</sub> = 2.7 V	0.4	0.1	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	0.7	0.2	-	ns
f <sub>max</sub>	maximum frequency	nCPAB; nCPBA; see Fig. 6				
		V <sub>CC</sub> = 2.3 V to 2.7 V	150	300	-	MHz
		V <sub>CC</sub> = 2.7 V	150	320	-	MHz
		V <sub>CC</sub> = 3.0 V to 3.6 V	150	320	-	MHz
C <sub>PD</sub>	power	per channel; $V_I = GND$ to $V_{CC}$ [5]				
	dissipation	output enabled	-	22	-	pF
	capacitance	output disabled	-	4.0	-	pF

- [1] Typical values are measured at T<sub>amb</sub> = 25 °C
  - Typical values for V $_{\rm CC}$  = 2.3 V to 2.7 V are measured at V $_{\rm CC}$  = 2.5 V
  - Typical values for  $V_{CC}$  = 3.0 V to 3.6 V are measured at  $V_{CC}$  = 3.3 V
- [2]  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .
- [3]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .
- [4]  $t_{dis}$  is the same as  $t_{PHZ}$  and  $t_{PLZ}$ .
- [5]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W):

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$$
 where:

f<sub>i</sub> = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

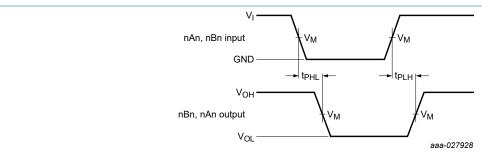
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$ 

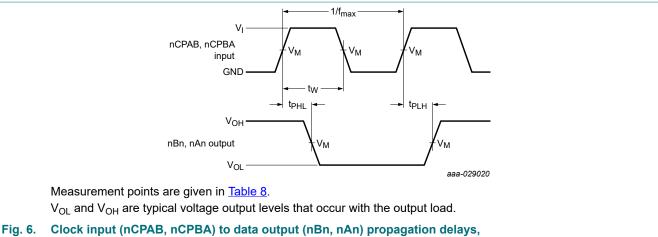
### 10.1. Waveforms and test circuit



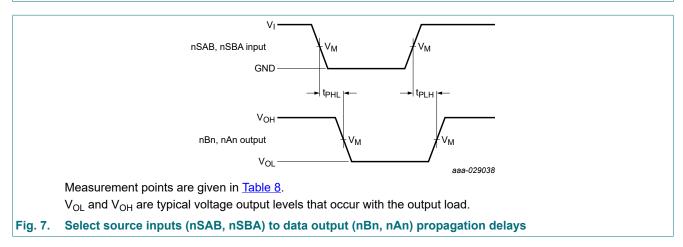
See Table 8 for measurement points.

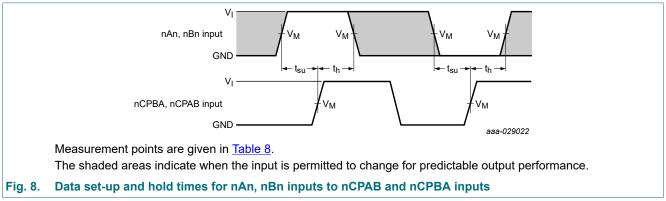
V<sub>OL</sub> and V<sub>OH</sub> are typical output voltage levels that occur with the output load.

Fig. 5. Input (nAn, nBn) to output (nBn, nAn) propagation delays

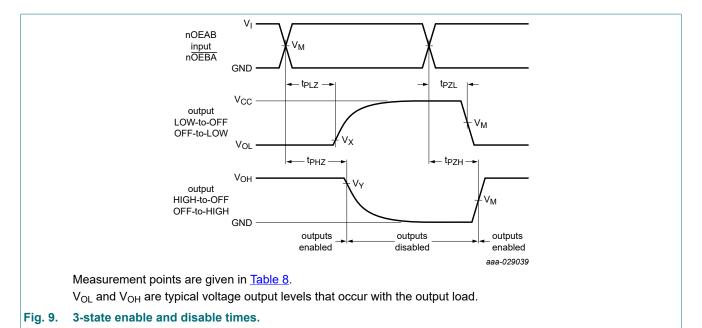


clock pulse width (nCPAB, nCPBA) and maximum clock frequency (nCPAB, nCPBA)





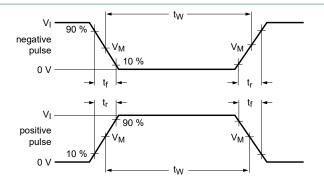
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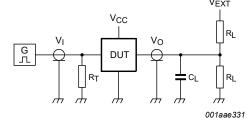


**Table 8. Measurement points** 

Supply voltage	Input		Output		
V <sub>CC</sub>	VI	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>
2.3 V to 2.7 V	V <sub>CC</sub>	0.5 × V <sub>CC</sub>	0.5 × V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V
2.7 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V

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Test data is given in Table 9.

Definitions for test circuit:

R<sub>L</sub> = Load resistance;

 $C_L$  = Load capacitance including jig and probe capacitance;

R<sub>T</sub> = Termination resistance should be equal to output impedance Z<sub>o</sub> of the pulse generator;

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

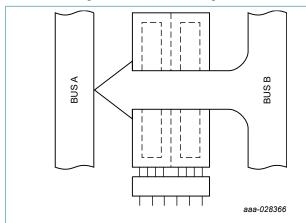
Fig. 10. Test circuit for measuring switching times

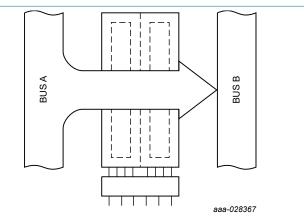
Table 9. Test data

Supply voltage	ltage Input		Load		V <sub>EXT</sub>		
V <sub>CC</sub>	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	CL	$R_L$	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>
2.3 V to 2.7 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	500 Ω	open	2 × V <sub>CC</sub>	GND
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	2 × V <sub>CC</sub>	GND
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	2 × V <sub>CC</sub>	GND

# 11. Application information

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care; \ \uparrow = LOW-to-HIGH \ clock \ transition$ 

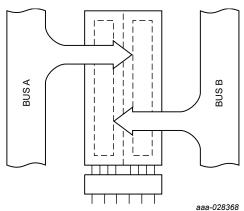




nOEAB	nOEBA	nCPAB	nCPBA	nSAB	nSBA
L	L	Χ	Χ	Χ	L

nOEABnOEBAnCPABnCPBAnSABnSBAHHXXLX

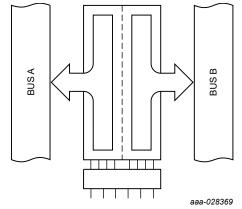
Fig. 11. Real time transfer bus B to bus A



nOEAB	nOEBA	nCPAB	nCPBA	nSAB	nSBA
Х	Н	1	Х	Х	Х
L	Х	Х	1	Х	Х
L	Н	1	1	Х	Х

Fig. 13. Store from bus A, B or A and B in one register

Fig. 12. Real time transfer bus A to bus B



nOEAB	nOEBA	nCPAB	nCPBA	nSAB	nSBA
Н	Н	H or L	X	Н	Х
L	L	Х	H or L	Х	Н
Н	L	H or L	H or L	Н	Н

Fig. 14. Transfer A stored data to B bus or B stored data to A bus or both at the same time

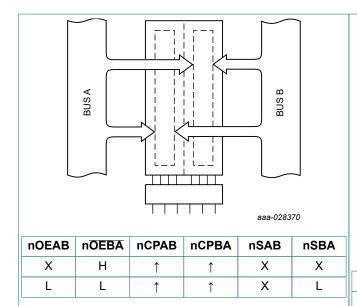


Fig. 15. Store bus A in both registers or store bus B in both registers

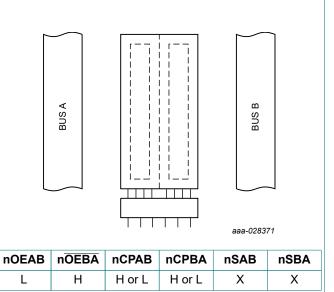
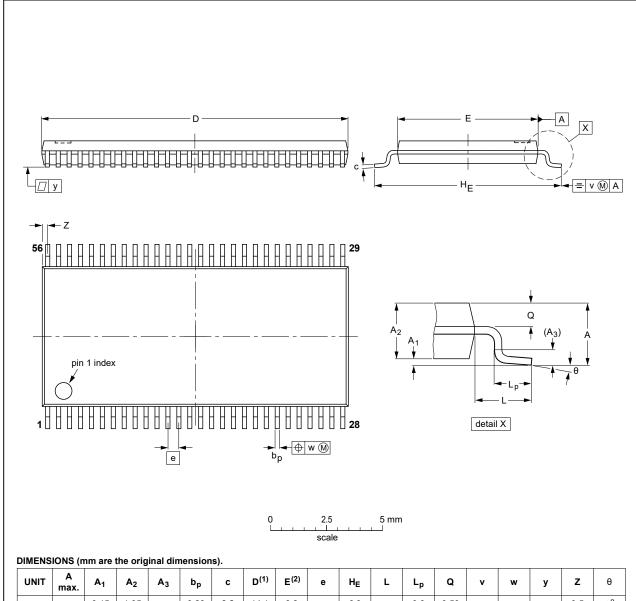


Fig. 16. Isolation

# 12. Package outline

### TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm

SOT364-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT364-1		MO-153				<del>99-12-27</del> 03-02-19

Fig. 17. Package outline SOT364-1 (TSSOP56)

## 13. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
НВМ	Human Body Model
JEDEC	Joint Electron Device Engineering Council
TTL	Transistor-Transistor Logic

# 14. Revision history

### **Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
74ALVCH16652 v.4	20240708	Product data sheet	-	74ALVCH16652 v.3
Modifications:		D specification updated accordal power dissipation upda	•	t JEDEC standard.
74ALVCH16652 v.3	20180912	Product data sheet	-	74ALVCH16652 v.2
Modifications:	of Nexperia.	this data sheet has been reave been adapted to the new		ly with the identity guidelines where appropriate.
74ALVCH16652 v.2	19991123	Product specification	-	74ALVCH16652 v.1
74ALVCH16652 v.1	19980831	Preliminary specification	-	-

## 15. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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#### 16-bit transceiver/register with dual enable; 3-state

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